

FPDCHINA



Key Attending Companies

- Amkor Assembly & Test (Shanghai) Co., Ltd.
- Beijing Chuangyu Technology Co., Ltd.
- CSMC Technologies Corporation
- EverDisplay Optronics (Shanghai) Limited
- Ferrotec
- Fudan University
- GF Securities
- Huawei
- Jiangsu Acetec Semiconductor Co., Ltd.
- Konfoong Materials International Co., Ltd.
- NAURA Technology Group Co., Ltd.
- Nexchip Semiconductor Corporation
- PEGATRON Corporation
- Samsung Electronics (Suzhou)
- Shanghai GenTech Co., Ltd.
- Shanghai Huahong Grace Semiconductor Manufacturing Corporation
- Shanghai Huali Microelectronics Corporation
- Shanghai Jiao Tong University
- SMC
- SMIC (Semiconductor Manufacturing International Corporation)
- Suzhou ASEN Semiconductor Co., Ltd.
- Tianshui Huatian Technology Co., Ltd.
- Tongfu Microelectronics Co., Ltd. (TFME)
- Toyoko Gas Equipments Co., Ltd.
- Wafer Works (Shanghai) Corp.

SEMICON® China 2018

March 14-16, 2018 SNIEC, Shanghai, China

Registration

| 91,252 |
|--------|
| 35,138 |
| 20,061 |
| 36,053 |
| |

International Attendance

| • | |
|--|----|
| Major Countries/Regions Represented (percentage of international SEMICON/FPD China visitors) | |
| South Korea 31% Malaysia | 4% |
| Taiwan Region 29% Hong Kong SAR | 3% |
| Japan 16% Germany | 2% |
| USA 6% United Kingdom | 1% |
| Singapore 5% Russia | 1% |

Total SEMICON/EDD China International Visitors

Exhibitor Information

| Total SEMICON/FPD China Exhibiting Companies | 1,116 |
|--|--------|
| Total Net Occupied Exhibit Area (sqm.) | 32,652 |
| Booths | 3,628 |



5 100

Co-located with



Visitor Profile

SEMICON China and FPD China attract a highly influential audience from every segment and sector of the global microelectronics industries, including semiconductors, LEDs, OLEDs, MEMS, flexible hybrid electronics, and other adjacent markets.

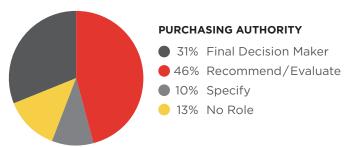
Influential Buyers

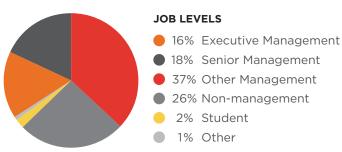
A majority of SEMICON China and FPD China visitors are involved in purchasing decisions, influencing the selection and final purchase of microelectronics manufacturing equipment, materials, components, and services.



50% of SEMICON China and FPD China visitors represent engineering functions, including R&D, Design, and Industrial Engineering.







Primary Job Functions

SEMICON China and FPD China attract multi-level buying teams, with broad representation across all levels, functions and industries.

| R&D | 14% |
|--|-----|
| Design | 11% |
| Equipment Engineering | 6% |
| Fabrication and Process Engineering | 6% |
| Packaging/Assembly | 3% |
| Test | 3% |
| Chemicals/Materials | 2% |
| Facilities/Engineering Support | 2% |
| Industrial Engineering | 1% |
| Quality Assurance/Failure Analysis/Reliability | 1% |
| Software Engineering | 1% |
| | |
| Marketing, Sales, Business Development | 19% |
| Purchasing/Procurement/Office Management | 6% |
| Product Management | 5% |
| Executive Management/Board Member | 4% |
| Financial/Industry Analyst/Investor Relations | 3% |
| Manufacturing/Operations Management/Production | 3% |
| Government/Public Policy | 1% |
| Integration/IT Support | 1% |
| Logistics/Supply Chain Management | 1% |
| Environment, Health and Safety (EHS) | <1% |
| Human Resources | <1% |
| Training/Education | <1% |
| Other Job Function | 5% |
| | |

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Co-located with

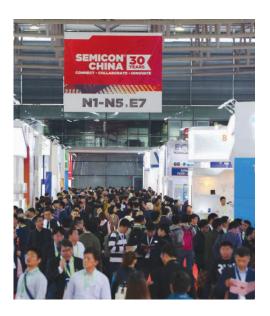


Areas of Interest

SEMICON China and FPD China visitors are interested in a broad range of industries, technologies, and products from across the supply chain, from design to final manufacturing.

INDUSTRIES/MARKETS SERVED

| Semiconductor | 82% |
|--|-----|
| Display/FPD | 14% |
| Photonics | 14% |
| LED/Solid State Lighting | 13% |
| MEMS | 13% |
| Sensors | 13% |
| Photovoltaic/Solar | 11% |
| EMS/Contract Manufacturing/ Precision Engineering | 10% |
| Consumer Electronics | 8% |
| Automotive/Transportation | 6% |
| Imaging | 6% |
| PCB Assembly | 6% |
| PCB Manufacturing | 6% |
| Flexible Hybrid Electronics/ Printed Electronics | 5% |
| Medical | 5% |
| Aerospace | 4% |
| Professional Services/Consulting | 4% |
| Software/Applications | 4% |
| Academia/University/R&D | 3% |
| Government | 2% |
| Association/Non-profit | 1% |
| Media/Publication | 1% |
| Other | 3% |
| | |



Areas of Interest

| MANUFACTURING TECHNO | LOGIES | | |
|--|--------|---|-------|
| Front-end Manufacturing | 42% | System Integration/ | 14% |
| (IDM, foundry) | | Product-level Manufacturing | |
| Packaging/Assembly | 37% | System-level Manufacturing | 13% |
| Design/EDA/IP | 35% | Board-level Manufacturing | 7% |
| Test | 33% | Roll-to-Roll/Printing | 7% |
| Material Engineering/ Materials Science | 31% | Other Manufacturing | 12% |
| APPLICATION INTERESTS | | | |
| Smart Manufacturing | 57% | Mobile Technologies/ | 18% |
| Artificial Intelligence | 32% | Wireless/5G | |
| Systems (AI) | | Virtual Reality/Augmented | 18% |
| Internet of Things (IoT) | 28% | Reality (VR/AR) | 12% |
| Automotive Electronics/ | | Medical Electronics/MedTech | 10% |
| Smart Transportation OLED | 220/ | Green Manufacturing/ | |
| | 22% | Cloud Computing/ High-performance Computing | 8% |
| Consumer Electronics Wearables | 21% | EHS Imaging | 8% |
| vvearables | 19% | Other Applications | 11% |
| | | Cities / (pp.) cations | 1170 |
| PRODUCT/SERVICE INTERE | | | |
| DESIGN/MANUFACTURING SER | | | 4=0/ |
| Foundries | 39% | Manufacturing Services and Consulting | 17% |
| Design/EDA | 32% | Factory Control/ | 14% |
| Packaging and Test Services (OSAT) | 32% | Process Software | 14 /0 |
| Fabless | 23% | Engineering Services | 13% |
| Electronic Manufacturing | 17% | R&D/Technology Transfer | 13% |
| Services (EMS)/System | 17 /0 | Other Design/Manufacturing | 11% |
| Integration | | Services | |
| MANUFACTURING EQUIPMENT | | | |
| Front-end Processing | 32% | Printing/Coating/Roll-to-Roll | 12% |
| Test | 26% | Secondary Equipment | 10% |
| Assembly/Packaging | 25% | and Services | |
| Factory Automation/Robotics | 19% | Components/Sub-systems/ | 8% |
| Inspection and Measurement/ | 15% | Instrumentation | |
| Metrology | | Abatement/Environmental | 5% |
| Large-area/Thin Film | 14% | Systems Other Manufacturing Fauin | 120/ |
| Parts | 13% | Other Manufacturing Equip. | 12% |
| MATERIALS | | | |
| Wafers/Substrates | 40% | Cleaning | 12% |
| Process Materials: Gases/ | 26% | Consumables | 11% |
| Liquids/Solids/Chemicals | | Inks/Pastes/Printing Materials | 8% |
| Packaging/Assembly | 24% | Other Materials | 14% |
| OTHER | | | |
| Support Products/Cleanroom | 20% | General Business Services/ | 11% |
| Representative Sales | 12% | Consulting | |
| and Service | | Standards | 8% |
| | | Other | 11% |
| | | | |



Co-located with



Sessions and Events



519

Grand Opening Keynote



356

SIIP China: Tech Innovation and Investment Forum - China 2018



209

Win-Win: Build China's IC Ecosystem



209

China Memory Strategic Forum



456

Power & Compound Semiconductor International Forum 2018



573

Smart Manufacturing Forum



235

Green Facility Technology Forum



173

MSIG International IOT Conference 2018



303

Smart Automotive Forum - Al Inside



268

2018 China Display Conference -Emerging Display Forum



288

New Technology Release Conference



683

China Semiconductor Technology International Conference 2018

